

**Product Summary**

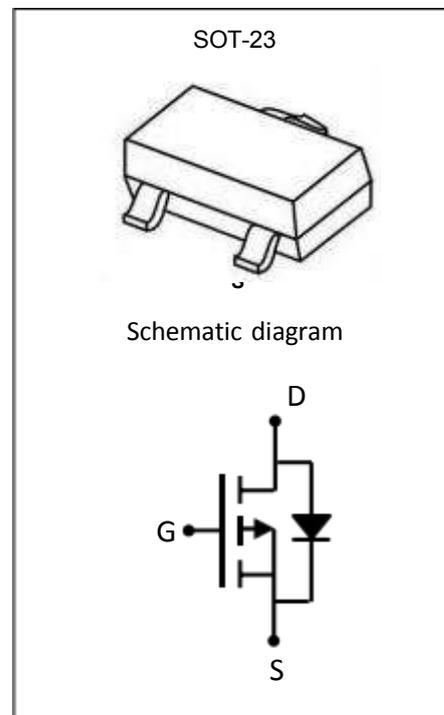
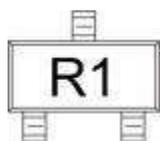
$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
-30V	65mΩ@-10V	-4.2A
	75mΩ@-4.5V	
	90mΩ@-2.5V	

**Feature**

- TrenchFET Power MOSFET
- Exceptional on-resistance and maximum DC current capability

**Application**

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

**MARKING:****ABSOLUTE MAXIMUM RATINGS ( $T_a=25^{\circ}\text{C}$  unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	±12	V
Continuous Drain Current	$I_D$	-4.2	A
Power Dissipation	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	357	$^{\circ}\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^{\circ}\text{C}$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}\text{C}$

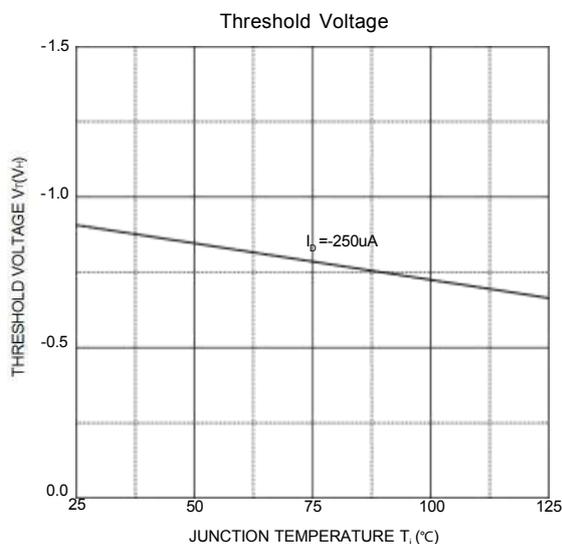
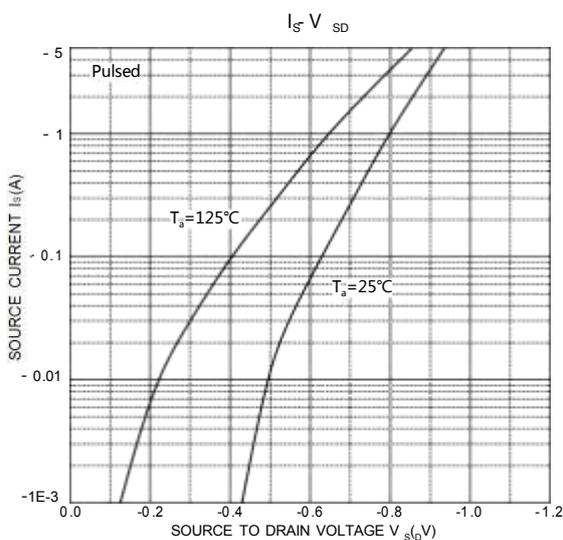
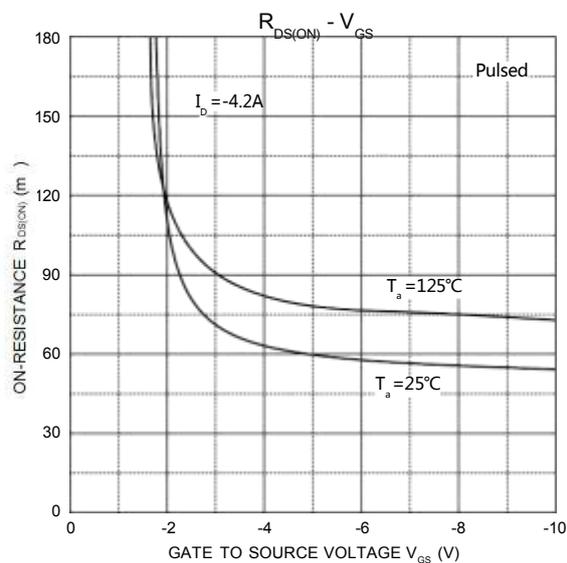
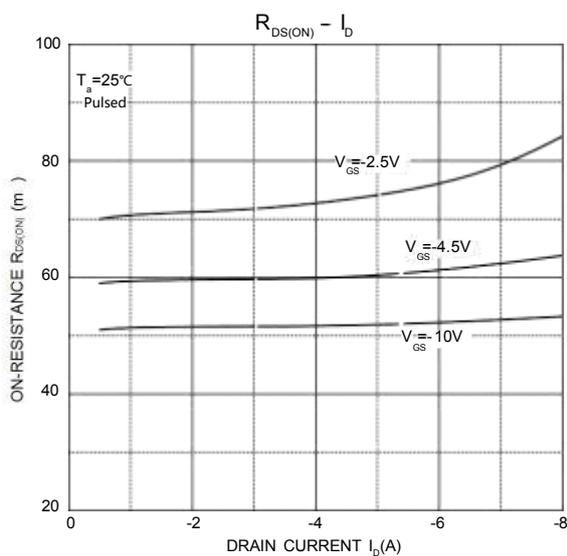
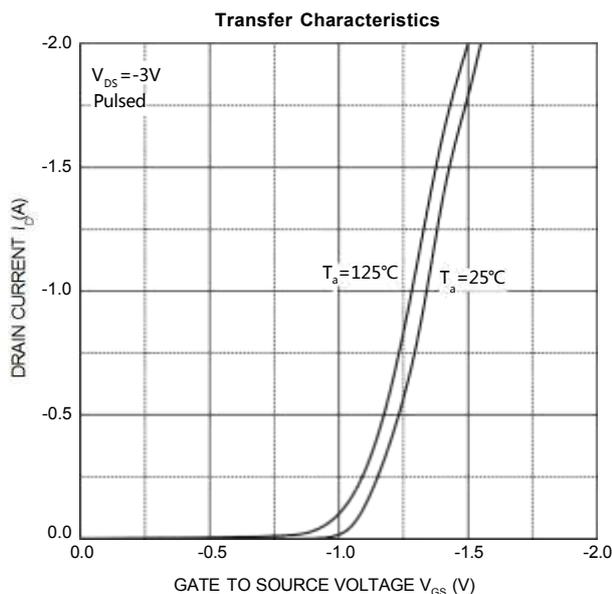
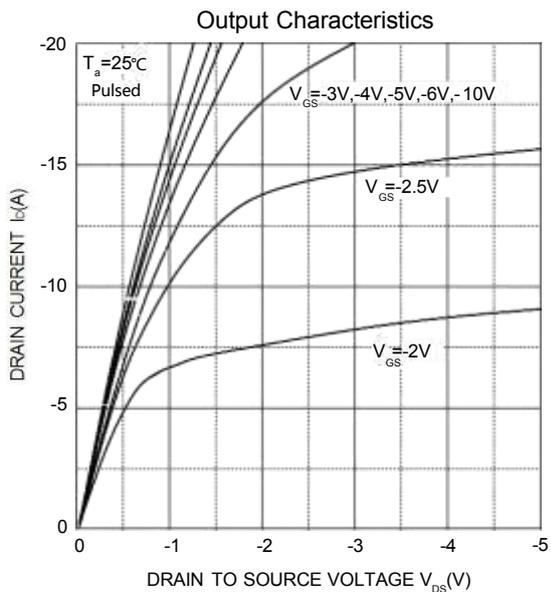
MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^{\circ}\text{C}$  unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -24V, V_{GS} = 0V$			-1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS} = 0V$			$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.7	-0.9	-1.3	V
Drain-source on-resistance <sup>(1)</sup>	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -4.2A$		50	65	m $\Omega$
		$V_{GS} = -4.5V, I_D = -4A$		60	75	
		$V_{GS} = -2.5V, I_D = -1A$		70	90	
Forward tranconductance <sup>(1)</sup>	$g_{FS}$	$V_{DS} = -5V, I_D = -4.2A$		10		S
<b>Dynamic characteristics<sup>(2)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -15V, V_{GS} = 0V, f = 1MHz$		954		pF
Output Capacitance	$C_{oss}$			115		
Reverse Transfer Capacitance	$C_{rss}$			77		
<b>Switching characteristics<sup>(2)</sup></b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = -10V, V_{DS} = -15V,$ $R_L = 3.6\Omega, R_{GEN} = 6\Omega$			6.3	ns
Turn-on rise time	$t_r$				3.2	
Turn-off delay time	$t_{d(off)}$				38.2	
Turn-off fall time	$t_f$				12	
<b>Source-Drain Diode characteristics</b>						
Diode forward current	$I_S$				-2	A
Diode pulsed forward current	$I_{SM}$				-25	A
Diode Forward voltage <sup>(1)</sup>	$V_{DS}$	$V_{GS} = 0V, I_S = -4.2A$			-1.2	V

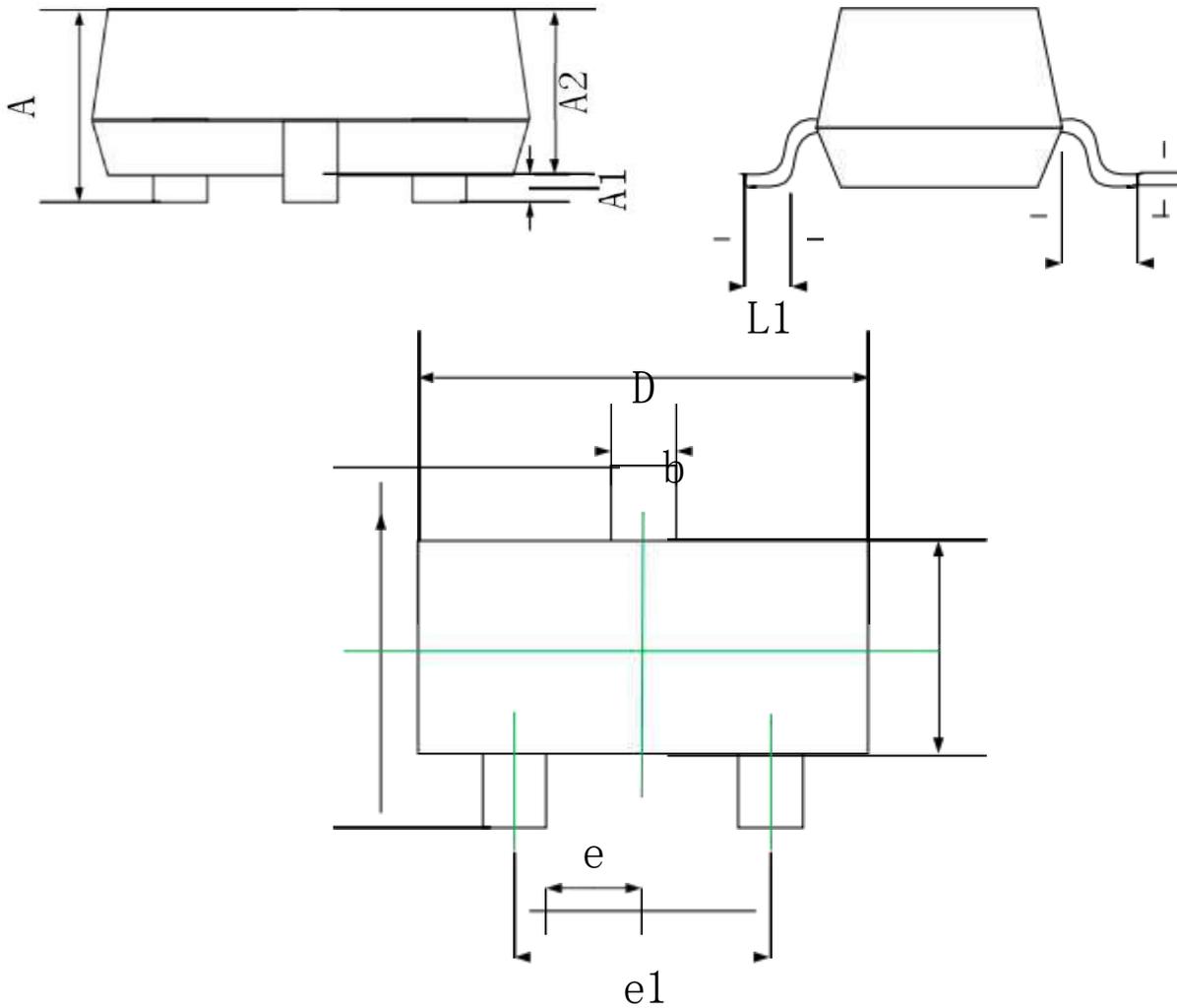
**Notes:**

1. Pulse test; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .
2. Guaranteed by design, not subject to production testing.

### Typical Electrical and Thermal Characteristics



### SOT-23 Package Information

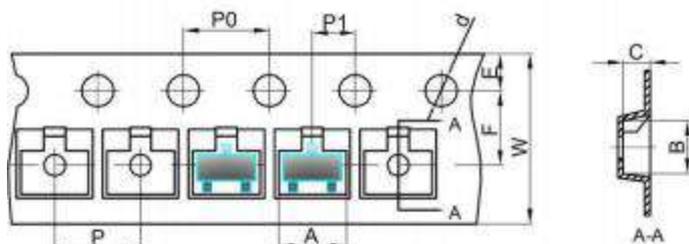


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	0.90	1.15
A1	0.00	0.10
A2	0.90	1.05
b	0.30	0.50
c	0.08	0.15
D	2.80	3.00
E	1.20	1.40
E1	2.25	2.55
e	0.95 REF.	
e1	1.80	2.00
L	0.55 REF.	
L1	0.30	0.50

### SOT-23 Tape and Reel

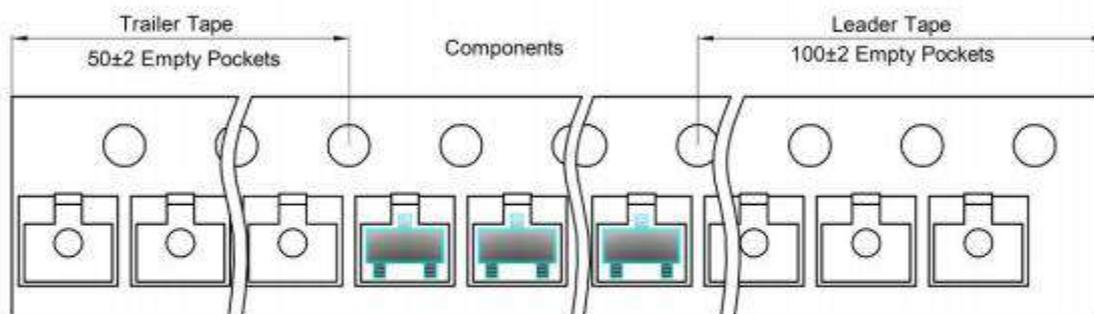
#### SOT-23 Tape and reel

SOT-23 Embossed Carrier Tape

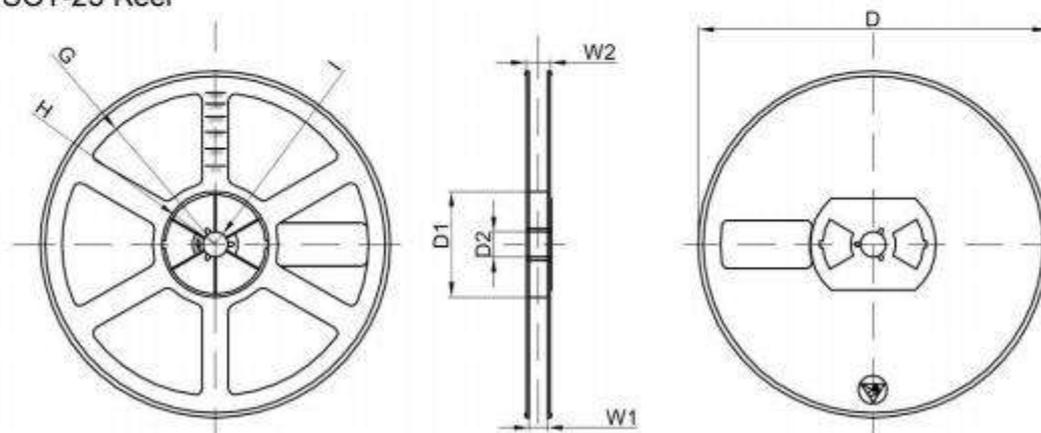


Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOT-23	3.15	2.77	1.22	Ø1.50	1.75	3.50	4.00	4.00	2.00	8.00

#### SOT-23 Tape Leader and Trailer



#### SOT-23 Reel



Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
7" Dia	Ø178.00	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 inch	30,000 pcs	203×203×195	120,000 pcs	438×438×220	

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    - b.support or sustain life,
    - c.whose failuer to when properly used in accordance with instructions for used provided in the laeling,can be reasonably expected to result in significant injury to the user.
  
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